



Material Content Data Sheet



Sales Product Name		IAUT200N08S5N023		Issued		1. August 2018		
MA#		MA001696564						
Package		PG-HSOF-8-1		Weight*		769.51 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.514	0.46	0.46	4566	4566
leadframe	inorganic material	phosphorus	7723-14-0	0.126	0.02		164	
	non noble metal	iron	7439-89-6	0.421	0.05		547	
	non noble metal	copper	7440-50-8	420.040	54.59	54.66	545851	546562
	non noble metal	aluminium	7429-90-5	10.027	1.30	1.30	13031	13031
wire	non noble metal	aluminium	7429-90-5	10.027	1.30	1.30	13031	13031
encapsulation	organic material	carbon black	1333-86-4	4.877	0.63		6337	
	plastics	epoxy resin	-	53.643	6.97		69710	
	inorganic material	silicondioxide	60676-86-0	266.590	34.64	42.24	346440	422487
leadfinish	non noble metal	tin	7440-31-5	6.479	0.84	0.84	8420	8420
plating	inorganic material	phosphorus	7723-14-0	0.001	0.00		2	
	non noble metal	nickel	7440-02-0	0.526	0.07	0.07	683	685
solder	non noble metal	tin	7440-31-5	0.065	0.01		85	
	noble metal	silver	7440-22-4	0.082	0.01		106	
	non noble metal	lead	7439-92-1	3.123	0.41	0.43	4058	4249
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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